

IAP5 Rec'd PCT/PTO 27 SEP 2006

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type:: REGULAR
 Subject Matter:: UTILITY
 CD-ROM or CD-R?: NONE
 Title:: EPOXY RESIN COMPOSITION FOR
 THE ENCAPSULATION OF
 SEMICONDUCTORS AND
 SEMICONDUCTOR DEVICES
 Attorney Docket Number:: 295408US40PCT

INVENTOR INFORMATION

Applicant Authority Type:: INVENTOR
 Primary Citizenship Country:: Japan
 Status:: FULL CAPACITY
 Given Name:: Daisuke
 Family Name:: HIROKANE
 City of Residence:: Utsunomiya-shi
 State or Province of Residence:: Tochigi
 Country of Residence:: Japan
 Street of Mailing Address:: c/o Utsunomiya Plant., SUMITOMO
 BAKELITE CO., LTD., 20-7, Kiyohara-
 Kogyodanchi
 City of Mailing Address:: Utsunomiya-shi
 State or Province of Mailing Address:: Tochigi
 Country of Mailing Address:: Japan
 Postal or Zip Code of Mailing Address:: 321-3231

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

DOMESTIC PRIORITY INFORMATION

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP05/04705	03/10/05

FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
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2004-100256	Japan	03/30/04	YES
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ASSIGNMENT INFORMATION

Assignee Name:: SUMITOMO BAKELITE CO., LTD.
 Street of Mailing Address:: 5-8, Higashishinagawa 2-chome
 City of Mailing Address:: Shinagawa-ku
 State or Province of Mailing Address:: Tokyo
 Country of Mailing Address:: Japan
 Postal or Zip Code of Mailing Address:: 140-0002